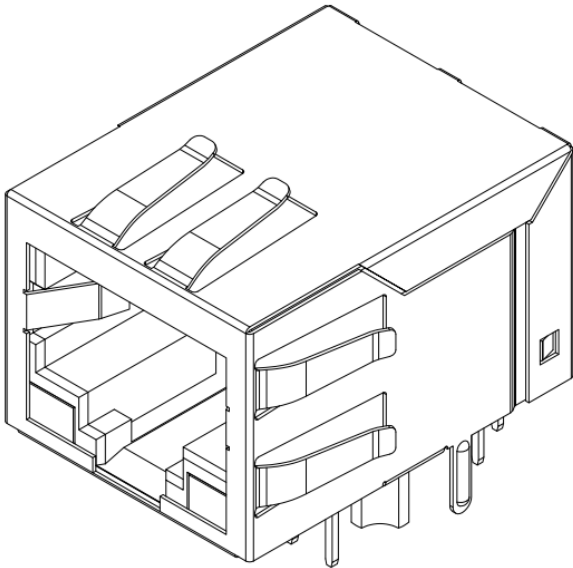


# PRODUCT SPECIFICATION

|                     |                                                                             |          |    |         |      |          |    |
|---------------------|-----------------------------------------------------------------------------|----------|----|---------|------|----------|----|
| Part Number         | MGC005                                                                      | Rev      | A  |         | Date | 15/10/25 |    |
| Product Description | Modular Jack, With Shell, With LED, With Magnetics, R/A, Through Hole, 2.5G |          |    |         | Page | 1        |    |
| Doc Number          | MGC005                                                                      | Prepared | CC | Checked | YR   | Approved | PH |



# PRODUCT SPECIFICATION

|                     |                                                                             |          |    |         |      |          |    |
|---------------------|-----------------------------------------------------------------------------|----------|----|---------|------|----------|----|
| Part Number         | MGC005                                                                      | Rev      | A  |         | Date | 15/10/25 |    |
| Product Description | Modular Jack, With Shell, With LED, With Magnetics, R/A, Through Hole, 2.5G |          |    |         |      | Page     | 2  |
| Doc Number          | MGC005                                                                      | Prepared | CC | Checked | YR   | Approved | PH |

## 1.0 SCOPE

This specification covers performance, tests and quality requirements for the Modular Jack, With Shell, With LED, With Magnetics, MGC005.

## 2.0 PRODUCT NAME AND PART NUMBER

Magnetic Modular Jack Connector – MGC005

## 3.0 PRODUCT SHAPE, DIMENSIONS AND MATERIAL

Please refer to drawing.

## 4.0 RATINGS

Storage Temperature ..... -40°C to +85°C

Operating Temperature Range ..... -40°C to +85°C

## 5.0 TEST AND MEASUREMENT CONDITIONS

Product is designed to meet electrical, mechanical and environmental performance requirements specified in Paragraph 6.0. All tests are performed under the following conditions unless otherwise specified.

# PRODUCT SPECIFICATION

|                     |                                                                             |          |    |         |      |          |    |
|---------------------|-----------------------------------------------------------------------------|----------|----|---------|------|----------|----|
| Part Number         | MGC005                                                                      | Rev      | A  |         | Date | 15/10/25 |    |
| Product Description | Modular Jack, With Shell, With LED, With Magnetics, R/A, Through Hole, 2.5G |          |    |         |      | Page     | 3  |
| Doc Number          | MGC005                                                                      | Prepared | CC | Checked | YR   | Approved | PH |

## 6.0 PERFORMANCE

| Item                   | Test Condition                                                     | Requirement                                                           |
|------------------------|--------------------------------------------------------------------|-----------------------------------------------------------------------|
| Examination of Product | Visual, dimensional and functional inspection as per quality plan. | Product shall meet requirements of product drawing and specification. |

### 6.1 Electrical Performance

| Item                  | Test Condition                                                                                                                                                                                        | Requirement                                       |
|-----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|
| Insulation Resistance | Apply 500VDC between adjacent terminals and in accordance with EIA-364-21                                                                                                                             | 500MΩ Min.                                        |
| Hi-Pot                | Apply 2250VDC for 60s between all contacts on the PHY side to the contacts on the cable side and the contacts of the PHY side to the shell, 500VDC between LED to shell in accordance with EIA-364-20 | No breakdown                                      |
| LED Function test     | Energise LEDs at rated current and voltage.                                                                                                                                                           | All LEDs illuminate and meet visual requirements. |

### 6.2 Mechanical Performance

| Item                              | Test Condition                                                                                                                                                                                                                | Requirement                                                                   |
|-----------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------|
| Durability                        | 750 Cycles in accordance with EIA-364-09                                                                                                                                                                                      | Appearance: No Damage.<br>Mating force: 23N Max.<br>Un-mating force: 10N Min. |
| Solderability Test                | Soldering Time: 4-5 seconds at a solder temperature of 245 ±5°C and in accordance with EIA-364-52                                                                                                                             | 95% minimum Solder Area                                                       |
| Resistance to Soldering Heat Test | Solder tails shall be dipped 2mm in the solder bath of 260 ±5°C for 5 ±1 seconds. In accordance with EIA-364-52                                                                                                               | No damage                                                                     |
| Mating/Un-mating Force            | Insertion speed at 25 ±3mm per minute and in accordance with EIA-364-13                                                                                                                                                       | Mating force: 23N Max.<br>Un-mating force: 10N Min.                           |
| Vibration                         | Insert plug into connector and expose to 10 to 55 to 10 Hz frequency span over 1 minute at a 1.52mm amplitude for a total of 2 hours. Test to be conducted on 3 mutually perpendicular planes. In accordance with EIA-364-28. | Appearance: No Damage.<br>Discontinuity: 1.0 μ second Max.                    |

# PRODUCT SPECIFICATION

|                     |                                                                             |          |    |         |      |          |    |
|---------------------|-----------------------------------------------------------------------------|----------|----|---------|------|----------|----|
| Part Number         | MGC005                                                                      | Rev      | A  |         | Date | 15/10/25 |    |
| Product Description | Modular Jack, With Shell, With LED, With Magnetics, R/A, Through Hole, 2.5G |          |    |         |      | Page     | 4  |
| Doc Number          | MGC005                                                                      | Prepared | CC | Checked | YR   | Approved | PH |

## 6.3 Environmental Performance

| Item                  | Test Condition                                                                                                                      | Requirement  |
|-----------------------|-------------------------------------------------------------------------------------------------------------------------------------|--------------|
| High Temperature life | +85 $\pm$ 2°C, 500 hours<br>In accordance with EIA-364-17                                                                           | No damage    |
| Low Temperature       | Mated with plug and exposed to the condition of -40 $\pm$ 3 for 96 hours. Recovery time 1~2 hours and in accordance with EIA-364-59 | No damage    |
| Humidity              | +40 $\pm$ 2°C, 90~95% RH, 96 hours<br>In accordance with EIA-364-31                                                                 | No damage    |
| Salt Spray            | +35 $\pm$ 2°C, salinity 5 $\pm$ 1%,<br>LED solder tails: 8 hours<br>Terminal and shell: 24 hours<br>In accordance with EIA-364-26   | No corrosion |

## 6.4 Magnetics Electrical Performance

| Item             | Test Condition                                        | Requirement                                                                                                                                          |
|------------------|-------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| Turn Ratio       | Mated Connectors                                      | (1-2):(J1-J2) = 1CT:1CT( $\pm$ 2%)<br>(3-4):(J3-J6) = 1CT:1CT( $\pm$ 2%)<br>(5-6):(J4-J5) = 1CT:1CT( $\pm$ 2%)<br>(7-8):(J7-J8) = 1CT:1CT( $\pm$ 2%) |
| OCL (Inductance) | PHY and Cable side, Measured at 100KHz, 100mV, 8mA DC | 180uH min.                                                                                                                                           |
| Insertion Loss   | Mated Connectors<br>IEC 60512-28-100                  | 1-125MHz, -1.0dB max.                                                                                                                                |
| Return Loss      | Mated Connectors<br>IEC 60512-28-100                  | 1-40MHz, -20dB min.<br>40-200MHz,<br>-20+15LOG <sub>10</sub> (f/40MHz) min.                                                                          |
| Cross Talk       | Mated Connectors<br>IEC 60512-28-100                  | 1-125MHz, -30dB min.                                                                                                                                 |
| CMR              | Mated Connectors<br>IEC 60512-28-100                  | 30-200MHz, -30dB min.                                                                                                                                |

# PRODUCT SPECIFICATION

|                     |                                                                             |          |    |         |      |          |    |
|---------------------|-----------------------------------------------------------------------------|----------|----|---------|------|----------|----|
| Part Number         | MGC005                                                                      | Rev      | A  |         | Date | 15/10/25 |    |
| Product Description | Modular Jack, With Shell, With LED, With Magnetics, R/A, Through Hole, 2.5G |          |    |         |      | Page     | 5  |
| Doc Number          | MGC005                                                                      | Prepared | CC | Checked | YR   | Approved | PH |

## 7.0 TEST GROUP AND SEQUENCE

| Item              | Description                       | Test Group    |      |      |      |      |      |      |      |     |     |
|-------------------|-----------------------------------|---------------|------|------|------|------|------|------|------|-----|-----|
|                   |                                   | A             | B    | C    | D    | E    | F    | G    | H    | I   | J   |
|                   |                                   | Test Sequence |      |      |      |      |      |      |      |     |     |
| 1                 | Examination or product            | 1, 5          | 1, 7 | 1, 3 | 1, 3 | 1, 3 | 1, 3 | 1, 3 | 1, 3 | 1,3 | 1,8 |
| 2                 | Insulation resistance             |               | 2, 5 |      |      |      |      |      |      |     |     |
| 3                 | Hi-Pot                            |               | 3, 6 |      |      |      |      |      |      |     |     |
| 4                 | Solderability                     |               |      | 2    |      |      |      |      |      |     |     |
| 5                 | Resistance to soldering Heat Test |               |      |      | 2    |      |      |      |      |     |     |
| 6                 | LED Function test                 |               |      |      |      | 2    |      |      |      |     |     |
| 7                 | Durability                        | 3             |      |      |      |      |      |      |      |     |     |
| 8                 | Mating force                      | 2, 4          |      |      |      |      |      |      |      |     |     |
| 9                 | Vibration                         |               |      |      |      |      | 2    |      |      |     |     |
| 10                | High Temperature life             |               |      |      |      |      |      | 2    |      |     |     |
| 11                | Low Temperature                   |               |      |      |      |      |      |      | 2    |     |     |
| 12                | Humidity                          |               | 4    |      |      |      |      |      |      |     |     |
| 13                | Salt spray                        |               |      |      |      |      |      |      |      | 2   |     |
| 14                | Turn Ratio                        |               |      |      |      |      |      |      |      |     | 2   |
| 15                | Insertion Loss                    |               |      |      |      |      |      |      |      |     | 3   |
| 16                | Return Loss                       |               |      |      |      |      |      |      |      |     | 4   |
| 17                | Cross Talk                        |               |      |      |      |      |      |      |      |     | 5   |
| 18                | CMR                               |               |      |      |      |      |      |      |      |     | 6   |
| 19                | OCL                               |               |      |      |      |      |      |      |      |     | 7   |
| Sample Size (pcs) |                                   | 3             | 3    | 3    | 3    | 3    | 3    | 3    | 3    | 3   | 3   |

PRODUCT SPECIFICATION

|                     |                                                                             |          |    |         |      |          |    |
|---------------------|-----------------------------------------------------------------------------|----------|----|---------|------|----------|----|
| Part Number         | MGC005                                                                      | Rev      | A  |         | Date | 15/10/25 |    |
| Product Description | Modular Jack, With Shell, With LED, With Magnetics, R/A, Through Hole, 2.5G |          |    |         | Page | 6        |    |
| Doc Number          | MGC005                                                                      | Prepared | CC | Checked | YR   | Approved | PH |

Revision details:

| Revision | Information          | Page | Release Date |
|----------|----------------------|------|--------------|
| 0.1      | First draft          | -    | 25/08/2025   |
| 0.2      | Updated after review | -    | 11/09/2025   |
| A        | First release        | -    | 15/10/2025   |
|          |                      |      |              |